

# **Description**

The VSM3420 uses advanced trench technology to provide excellent  $R_{\rm DS(ON)}$ , low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a uni-directional or bi-directional load switch.

#### **General Features**

• V<sub>DS</sub> = 20V,I<sub>D</sub> = 6A

 $R_{DS(ON)}$  < 40m $\Omega$  @  $V_{GS}$ =2.5V

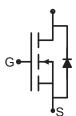
 $R_{DS(ON)}$  < 33m $\Omega$  @  $V_{GS}$ =4.5V

- High Power and current handing capability
- Surface Mount Package
- Pb free terminal plating
- RoHS compliant
- Halogen free

### **Application**

- Uni-directional Load switch
- Bi-directional Load switch





SOT-23-3

Schematic Diagram

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM3420-S2	VSM3420	SOT-23-3	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	20	V	
Gate-Source Voltage	Vgs	±12	V	
Drain Current-Continuous	I <sub>D</sub>	6	Α	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	30	Α	
Maximum Power Dissipation	P <sub>D</sub>	1.25	W	
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$	

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	100	°C/W
,			

# **Electrical Characteristics (T<sub>A</sub>=25**°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20	22	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μΑ	



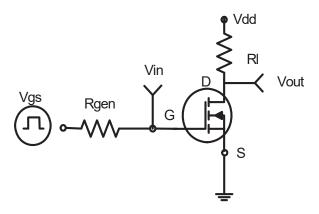
Parameter	Symbol	Condition	Min	Тур	Max	Unit		
Gate-Body Leakage Current I <sub>GS</sub>		V <sub>GS</sub> =±12V,V <sub>DS</sub> =0V	-	-	±100	nA		
On Characteristics (Note 3)								
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	0.5	0.7	1.0	V		
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =2.5V, I <sub>D</sub> =4.0 A	-	21	40	mΩ		
Diam-Source On-State Resistance		V <sub>GS</sub> =4.5V, I <sub>D</sub> =5.0A	-	18	33	mΩ		
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =5A	-	25	-	S		
Dynamic Characteristics (Note4)	Dynamic Characteristics (Note4)							
Input Capacitance	C <sub>lss</sub>		-	424.5	-	PF		
Output Capacitance	Coss	$V_{DS}$ =10V, $V_{GS}$ =0V, F=1.0MHz	-	59.5	-	PF		
Reverse Transfer Capacitance	C <sub>rss</sub>	F-1.UIVITZ	-	51.5	-	PF		
Switching Characteristics (Note 4)	·							
Turn-on Delay Time	t <sub>d(on)</sub>		-	3	-	nS		
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =10V, $R_L$ =2 $\Omega$	-	7.5	-	nS		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =3 $\Omega$	-	20	-	nS		
Turn-Off Fall Time	t <sub>f</sub>		-	6	-	nS		
Total Gate Charge	Qg		-	12	-	nC		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =10V,I <sub>D</sub> =5A,V <sub>GS</sub> =10V	-	1	-	nC		
Gate-Drain Charge	Q <sub>gd</sub>		-	2	-	nC		
Drain-Source Diode Characteristics								
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =5A	-	-	1.2	V		
Diode Forward Current (Note 2)	Is		-	-	6	Α		

### Notes:

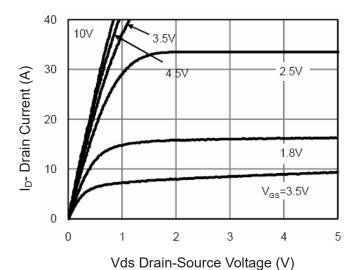
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- **4.** Guaranteed by design, not subject to production



# **Typical Electrical and Thermal Characteristics**



**Figure 1:Switching Test Circuit** 



**Figure 3 Output Characteristics** 

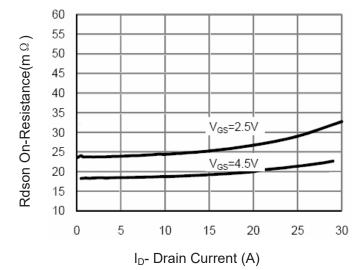


Figure 5 Drain-Source On-Resistance

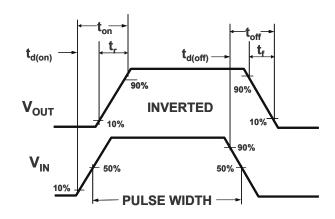
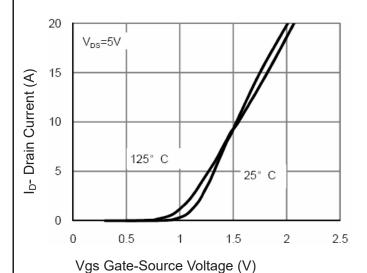


Figure 2:Switching Waveforms



**Figure 4 Transfer Characteristics** 

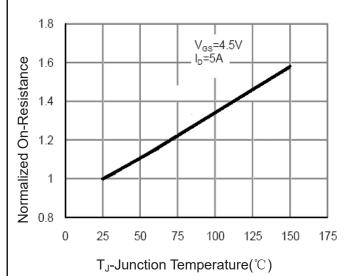
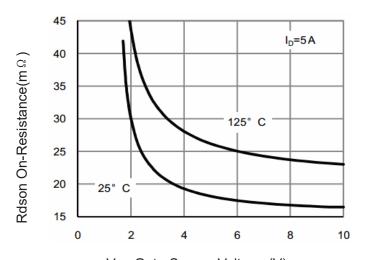
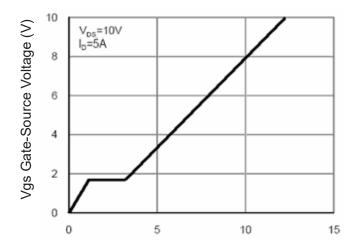


Figure 6 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V) Figure7 Rdson vs Vgs



Qg Gate Charge (nC) Figure 9 Gate Charge

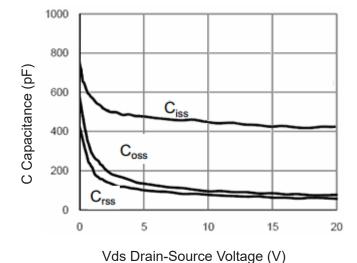


Figure 11 Capacitance vs Vds

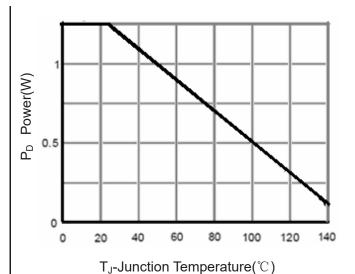


Figure 8 Power Dissipation

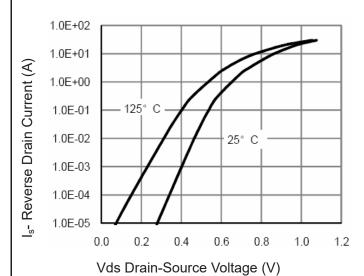
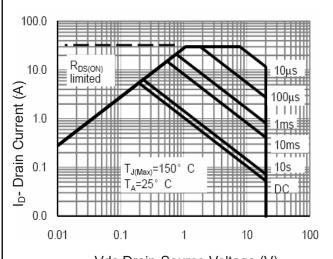


Figure 10 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)
Figure 12 Safe Operation Area



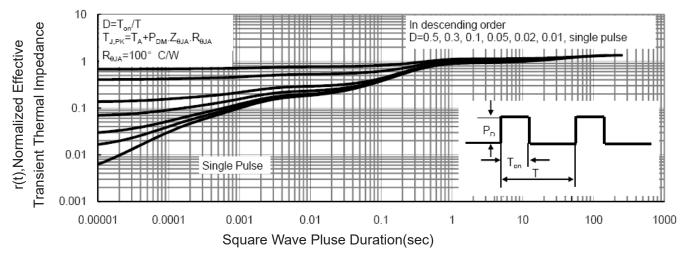


Figure 13 Normalized Maximum Transient Thermal Impedance